

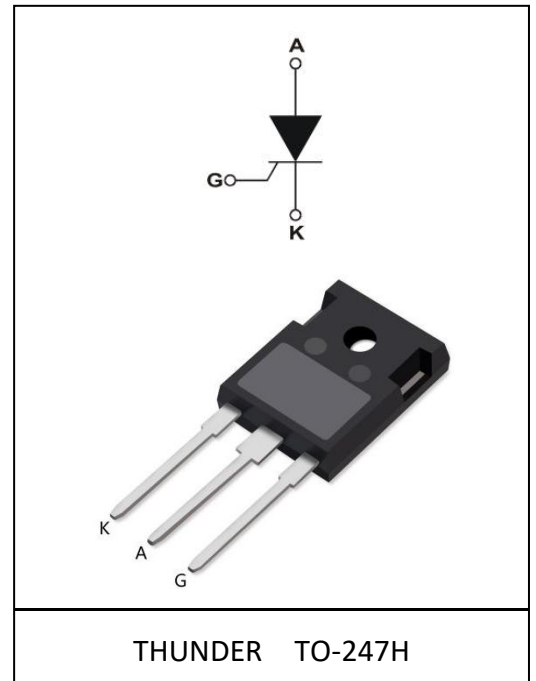
Silicon Controlled Rectifier

Description

BCB75-1600KH, with high ability to withstand the shock loading of large current, provide high dv/dt rate with strong resistance to electromagnetic interference.

Main Features

Product Summary	
V_{DRM}/V_{RRM}	1600V
$I_{T(RMS)}$	75A
I_{GT}	30~80mA



Absolute Maximum Ratings:

Symbol	Parameter	Value	Unit
T_{stg}	Storage junction temperature range	-40-150	°C
T_j	Operating Junction Temperature	-40-150	°C
V_{DRM}	Repetitive peak off-state voltage	1600	V
V_{RRM}	Repetitive peak reverse voltage	1600	V
$I_{T(AV)}$	average on-state current	53	A
$I_{T(RMS)}$	RMS on-state current($T_c=25^\circ\text{C}$)	75	A
I_{TSM}	Non repetitive surge peak on-state voltage($t_p=10\text{ms}$)	750	A
I^2t	I^2t value for fusing ($t_p=10\text{ms}$)	2800	A ² S
di/dt	Critical rate of rise of on-state current($I_G=2*I_{GT}$)	150	A/ μS
I_{GM}	Peak gate current	4	A
$P_{G(AV)}$	Average gate power dissipation	1	W
P_{GM}	Peak gate power	5	

Electrical Parameters ($T_j=25^\circ\text{C}$ unless otherwise specified)

Symbol	Test Conditions	Min.	Typ.	Max.	Unit
I_{GT}	$V_D=12\text{V}$ $R_L=33\Omega$	30		80	mA
V_{GT}				1.5	V
V_{GD}	$V_D=V_{DRM}$ $T_j=125^\circ\text{C}$ $R_L=3.3\text{k}\Omega$	0.25			V
I_L	$I_G=1.2I_{GT}$	60			mA
I_H	$I_T=1\text{A}$	30			mA
dv/dt	$V_D=2/3V_{DRM}$ $T_j=125^\circ\text{C}$ Gate Open	1000			V/ μs

Static Characteristics

Symbol	Test Conditions	T _j (°C)	Min.	Typ.	Max.	Unit
V _{TM}	I _{TM} =75A tp=380μs	25			1.40	V
I _{DRM}	V _D =V _{DRM} V _R =V _{RDM}	25			15	μA
I _{RDM}		125			10	mA

Thermal characteristics

Parameter	Symbol	Typ.	Unit
Junction-to-Case	R _{th(j-c)}	0.3	°C/W

Typical Performance Characteristics

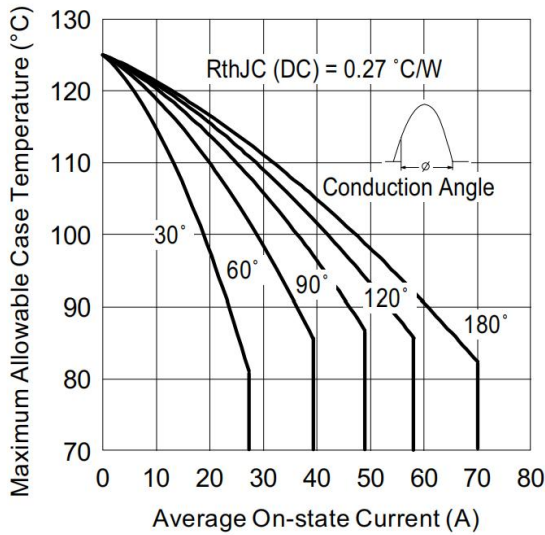


Fig. 1 - Current Rating Characteristics

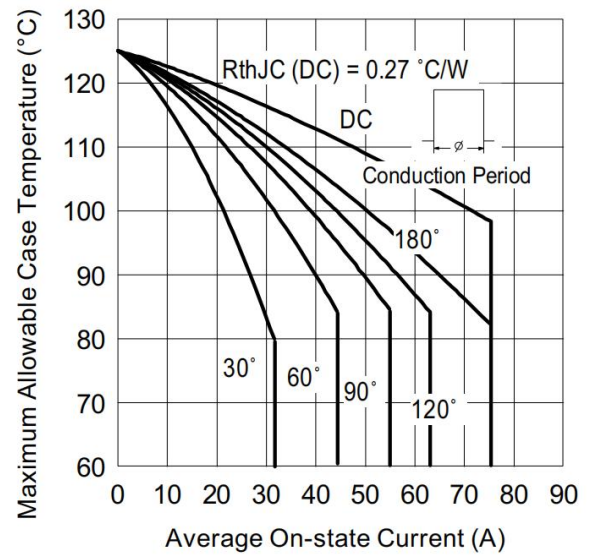


Fig. 2 - Current Rating Characteristics

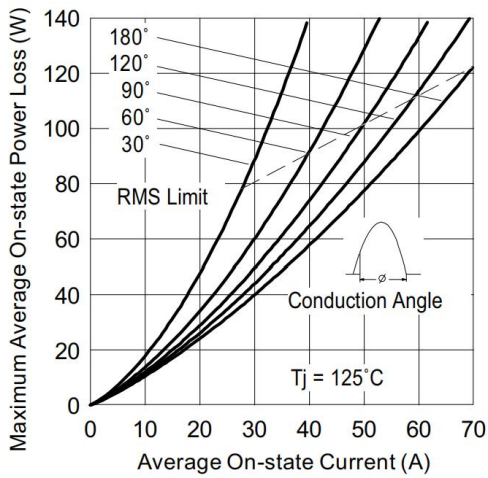


Fig. 3 - On-State Power Loss Characteristics

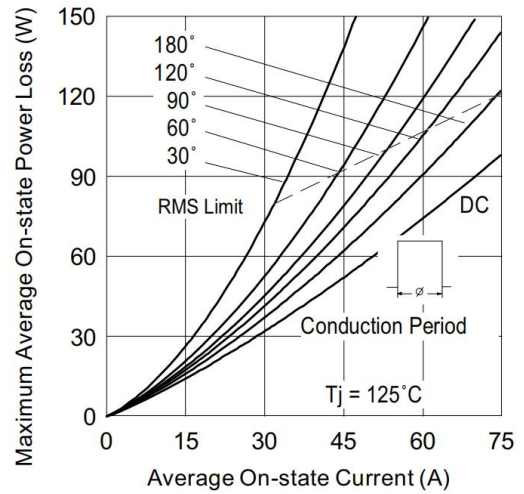


Fig. 4 - On-State Power Loss Characteristics

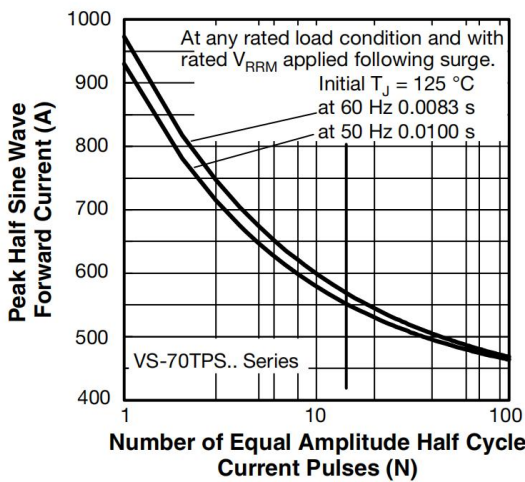


Fig. 5 - Maximum Non-Repetitive Surge Current

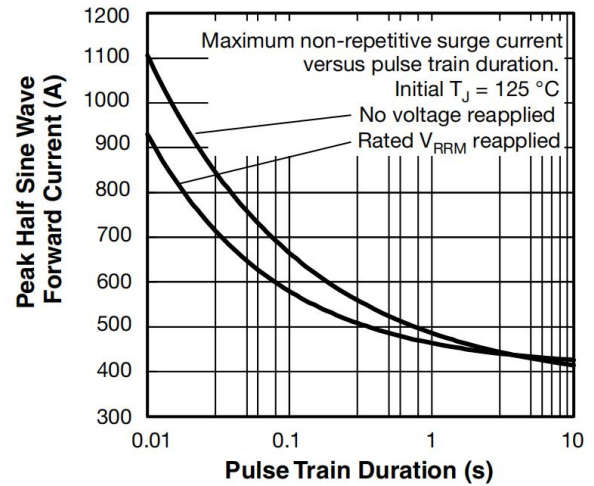


Fig. 6 - Maximum Non-Repetitive Surge Current

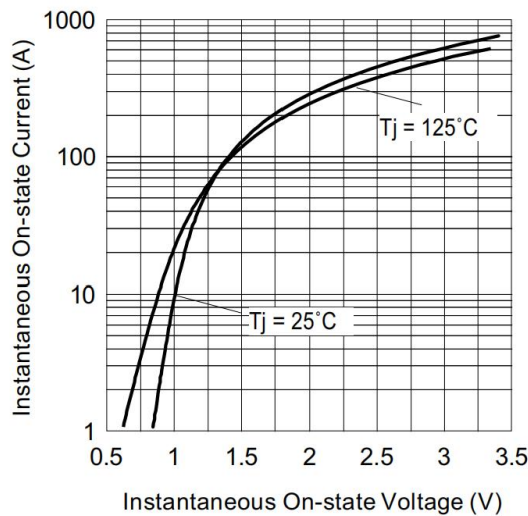
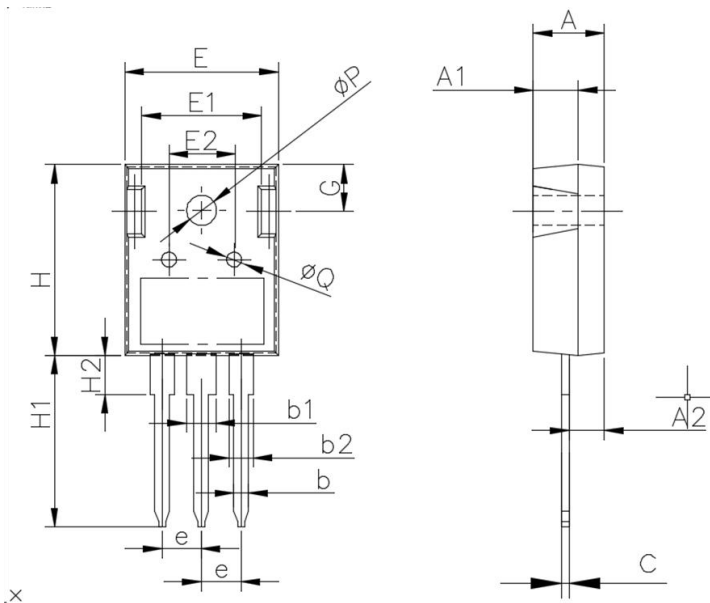


Fig. 7 - On-State Voltage Drop Characteristics

Package Information

TO-247H PACKAGE

基本尺寸



Symbol	单位 mm		
	Min	Nom	Max
A	4.80	5.00	5.20
A1	2.80	3.00	3.20
A2	2.20	2.40	2.60
b	1.05	1.20	1.35
b1	2.80	3.00	3.20
b2	1.80	2.00	2.20
c	0.50	0.60	0.70
e	5.35	5.45	5.75
E	15.6	15.80	16.0
E1	12.3	12.50	12.7
E2	6.00	6.20	6.40
H	20.8	21.0	21.2
H1	19.5	20.0	20.5
H2	3.70	4.00	4.30
G	5.70	5.90	6.10
ΦP	3.30	3.50	3.70
ΦQ	2.30	2.50	2.70

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